Led by experience. Driven by curiosity.

Cheetah EVO

Efficient inspections with crystal clear images for SMT, semiconductors and labs.





Comet Yxlon this is who we are.

Comet Yxlon designs and manufactures high-end X-ray and CT system solutions for industrial environments – based on customer-centric product development. We're proud to be part of Comet, the globally leading Swiss technology company with a focus on plasma control and X-ray technology.

Led by experience. Driven by curiosity.

Deeper insights.

Looking beyond the surface is our core competency at Comet Yxlon but not only in a technical way.



Automated 2D and laminography inspection for maximum productivity.

Zooming in on your industry, applications and business challenges allows us to develop innovative and relevant solutions that help you shape future markets. Faster time to market? Avoiding production downtimes? The perfect image with the highest resolution, as fast and easy as possible? Whatever your goal - let's talk about it!

Your benefits with the Cheetah EVO:

- Outstanding CT quality: High detail resolution and scan repeatability due to water-cooled tube option.
- Increased efficiency through automated inspection and softwareassisted image review.
- Easy-to-use dynamic image enhancement filters
- Best available laminography
- Dose monitoring for sensitive parts
- Optional high load capacity (≤ 20 kg)

The smart choice for the smart factory.

Connectivity, self-optimizing processes, automation – Industry 4.0 demands new solutions. Challenge accepted: The Cheetah EVO helps increase speed, image quality, and efficiency in the SMT and semiconductor industry as well as in laboratories.

Increase yield

Deeper insights from repeatable scan results keep your production on target.

Improve your efficiency

Faster results due to dedicated inspection workflows boost your productivity.

Enhance your quality

Precise image details reveal process trends.

Already Aristotle realized: "The whole is greater than the sum of its parts". With the Cheetah EVO, it's the combination of state-of-the-art hardware like the new water-cooled tube, innovative visualization software and smart workflows like VoidInspect, that makes this system stand out.

New water-cooled FXT 160.51 X-ray tube

When the temperature of the tube housing and the target inside increases during the inspection process, focus drift may occur. Thanks to improved heat dissipation at the tube optics, Comet Yxlon's new water-cooled tube stabilizes the focal spot and significantly improves CT results – expect crystal clear CT images with higher resolution and less image distortion. This is also the basis for a significantly improved repeatability of results of 2D and laminography scans during, e.g., batch inspections - a vital guality for using the data in production process control.

Smart workflows and visualization

The Cheetah EVO responds to the need for improved, automated operation with integrated workflows in the FGUI operating software. Once images are captured, the Comet Yxlon FF CT software automatically performs a fast reconstruction of outstanding quality and, finally, offers brilliant visualization. It has a unique ability to render 3D cinematic images with a preset selection of transfer functions (TF), resulting in the most realistic, vivid visualization.

Large flat-panel detectors

The Cheetah's large flat-panel detectors offer an up to 50% larger field of view for a better overview. Manufacturers benefit from faster working processes due to the reduced number of steps in automated processes.

Production line integration with ProLoop

The Cheetah EVO supports ProLoop, Comet Yxlon's smart factory solution for the optimization of production processes. It enables direct communication with the inline AOI / AXI inspection systems and thus helps achieve maximum yield performance.

(≤ 20 kg)



The water-cooled FXT 160.51 tube delivers repeatable and precise scan results.

Optional high load capacity

The reinforced mechanics and sample table are suitable for components up to 20 kg, so several parts and electronic interconnects in fixed packages can be inspected at once - a real-time saver.

Different applications. Same great quality.

SMT inspections: grand performance for small devices

Due to the miniaturization and performance increase of more and more features must fit in an ever-smaller area. Cheetah enables accurate, repeatable inspection routines with void compilations, including multi-area voiding. It does not only provide high performance and resolution, but is also equipped with enhancement filters and powerful automation tools.



Computed laminography of PCB, clipping plane



PCB (BTC, BGA, LGA, QFN/QFP, THT)
IGBT
LED



Cheetah enables accurate, repeatable inspection routines with void compilations, including multi-area voiding. Its high detail resolution laminography is key for inspecting the internal connections of state-of-the-art advanced packaging IC devices.

Semiconductor applications

Wafers and integrated circuits (die attach connections, 3D IC joints, TSV)

Sensors

MEMS and MOEMS



Overview of BGA and bumps with laminography



3D visualization of a multi-layer board using the Comet Yxlon FF CT Software.

The inspection of electronic components during research and development is highly complex and requires a broad range of features. Computed tomography with the Comet Yxlon Cheetah EVO is the technology of choice for detailed analyses of micro components such as those used in batteries, connectors, and medical devices.

Lab applications

Batteries
Connectors and other electronics
Medical material
Military and space electronics

Laboratory inspections: leading technology for precise analysis

s components

Software solutions for accurate, repeatable, fast results.

From image acquisition with the FGUI user interface, to the reconstruction of the volume with FF CT software, to image analysis and evaluation: the Cheetah offers a wide range of integrated software features. They help increase the efficiency of manual labor – and save inspection cost per part.





THT with voids



Voids in BGA balls

THTInspect DR

THTInspect DR is the semi-automated defect analysis for fill level inspections on THT-based components in 2D. It enables an assisted inspection routine for quantitative analysis, in both sampling and batch testing and works with plated and non-plated pin holes. The evaluation results according to specification are visualized in green and red.

VoidInspect CL and DR

VoidInspect based on computed laminography (CL) or digital radioscopy (DR) is the first-class analysis tool of solder joints to identify and evaluate potential voids. It is an automated inspection routine for quantitative analysis, with very high accuracy and repeatability, that helps save time and minimize error. It is qualified for the inspection of electronic components like BGA, LGA, BTC and QFN Central Pads, LED, IGBT and DPAK.

2D multi area void calculation (MAVC)

QFNs and other bottom-terminated devices without overlapping can also be inspected with 2D digital radioscopy. Faulty or missing solder joints and large areas of voiding are reliably detected, and MAVC helps analyze voids in complex soldering designs. With just four parameters to adjust, setup is quick, simple, and costefficient. Precise void analysis of multi-layer components needs computed laminography and VoidInspect.

eHDR

invisible before.

Dose Monitoring

The Cheetah's Dose Monitoring technology prevents damaging X-ray sensitive electronics during the inspection process. The absorbed X-ray dose is automatically monitored - when a critical threshold is reached, the operator is informed and the scan is aborted.

Extended BGA inspection

Cheetah allows to quickly select and index individual balls, either manually or using automatic grid detection. A wizard guides the operator through the inspection process step-by-step and ensures perfectly accurate and repeatable results.

Automated sequences

The productivity of working with the Cheetah EVO on recurring test tasks can be significantly increased by automating and customizing test sequences via the scripting interface.

To ensure highest product quality, the eHDR filter highlights complex structures with just one click. Thanks to our advanced software and enhanced 16-bit gray scale values, it detects even the slightest variances in gray scale, so that no defect will be missed. This allows operators to easily see faults that were

Artifact reduction

Powerful image quality optimizations help improve the quality of the scan data, e.g. through BHR/BHC Beam Hardening Reduction/Correction, Ring Artifact Reduction or Noise Reduction.

Life Cycle Service: supporting you every step of the way.

At Comet Yxlon, service is not an add-on, but an integral part of every product. We support you through the entire life cycle of your system – for easy operation and extended product life.

Offline applications, at-line scenarios, or in-line implementation - Comet Yxlon supplies tailored service solutions for a wide range of production environments. Whether you are an X-ray beginner or a CT expert, whether you need introductory training or a performance upgrade: Our service team is here to support you.

1. Getting you started

Our professional Comet Yxlon field service technicians or certified service providers will ease your way into working with your new inspection system.

- Bringing the system to life: installation & commissioning
- Power on: introductory training by Comet Yxlon Academy
- Correct measurements from the start: SmartCalibration
- Cost transparency from the beginning: flat fee service rates

2. Running things smoothly

Is there an issue? No problem. Our skilled service technician team helps with troubleshooting, maintenance, and part exchange for easy operation.

- High efficiency thanks to remote control and VisualAssist
- Professional phone support and on-site visits
- Preventive maintenance and SmartExchange
- High-end system monitoring with SmartCalibration

3. Enhancing performance

With our upgrades and conversion kits, your Comet Yxlon system remains in top-notch condition and keeps its value as market demands change.

- System release upgrades, feature & performance upgrades
- Component upgrades
- System software upgrades
- Advanced Academy training

Tailor-made Service Level Agreements

Our Service Level Agreements are based on different performance factors, e.g.

ServicePass – for fast reaction times and seamless maintenance

SmartPass – focusing on the highest possible system availability

LifeCyclePass – the all-inclusive premium contract for guaranteed life-cycle-costs

Please contact us to learn more about the specifics of our different service contracts!

X-ray inspection system

Dimensions (w x d x h)	1,650 x 1,400 x 2,050 mm	Time to first image (typ.)	~ 10 s	
Weight	2,200 kg	Reconfiguration time (typ.)	< 60 s	
Mains connections	230 V ± 10% AC, 50/60 Hz, 1 Phase, neutral and ground conductor	230 V ± 10% AC, 50/60 Hz, 1 Phase, neutral and ground conductor (Quick Scan)		
Fuse protection	16 A	for 2000 projections Reconstruction time		
Max. power consumption	2.5 kVA	(Quick Scan)	~ 1.55 min	
Max. dose rate*	< 1µSv/h	for 2000 projections		
* at 100 mm distance to the cabinet surface		Acquisition time (micro3Dslice Semicon) for 120 projections	~ 1.45 min	
Max. part size 800 x 500 mm (31" x 19")		Reconstruction time	0.00	
Max. radiographic area	460 x 410 mm (18" x 16")	(micro3Dslice Semicon) for 120 projections	~ 0.30 min	
Max. part weight (standard)	5 kg	Access for sample loading	large automated door (690 x 650 mm)	
Max. part weight	2 kg	Cabinet window	520 x 370 mm	
rotation Max. part weight	20 kg	Monitor	27" Ultrasharp, wide viewing angles	
(high load capacity)	ZO kg Zoom+		yes	
Manipulation		PowerDrive	yes	
		Image stabilization	air suspension	
Manipulation control	via mouse or joystick			

Dimensions (w x d x h)	1,650 x 1,400 x 2,050 mm	Time to first image (typ.)	~ 10 s
Weight	2,200 kg	Reconfiguration time (typ.)	< 60 s ~ 3.15 min ~ 1.55 min
Mains connections	230 V ± 10% AC, 50/60 Hz, 1 Phase, neutral and ground conductor	Acquisition time (Quick Scan)	
Fuse protection	16 A	for 2000 projections Reconstruction time	
Max. power consumption	2.5 kVA	(Quick Scan)	
Max. dose rate*	< 1µSv/h	for 2000 projections	
* at 100 mm distance to the cabinet surface Inspection parts		Acquisition time (micro3Dslice Semicon) for 120 projections	~ 1.45 min
· ·		Reconstruction time	
Max. part size Max. radiographic area	800 x 500 mm (31" x 19") 460 x 410 mm (18" x 16")	(micro3Dslice Semicon) for 120 projections	~ 0.30 min large automated door (690 x 650 mm)
Max. part weight (standard)	5 kg	Access for sample loading	
Max. part weight	2 kg	Cabinet window	520 x 370 mm
rotation Max. part weight	20 kg	Monitor	27" Ultrasharp, wide viewing angles
(high load capacity)	20 kg	Zoom+	yes
Manipulation		PowerDrive	yes
		Image stabilization	air suspension
Manipulation control	via mouse or joystick		

Manipulation control	via mouse or joystick
Manipulation axes	X, Y, Z(D)*
Oblique viewing	+/-70° (140°)

* Manipulation options for horizontal and vertical rotation available

X-ray source	FXT-160.50 Microfocus	FXT-160.51 Multifocus	
Target	transmission		
Voltage range	20 – 160 kV		
Current range	0.001 – 1.0 mA		
Tube power	max. 64 W		
Target power	max. 15 W		
Target material	Tungsten		
Detail detectability	0.75 μm	< 0.3 µm	
X-ray intensity control	TXI		
Optional		Water-cooling	
Optional	Dose Reduction Kit with collimator and filters for sensitive test parts		

Image Chain

Geometric magnification	
Total magnification	
Spatial Resolution	1.5 µm

Flat-panel detector	1308	1313	1515	1616
Max. resolution Pixel	1004 x 620	1004 x 1004	1280 x 1280	1276 x 1276
Pixel size	127 µm	127 µm	119 µm	127 µm
Pixel Area	128 mm x 79 mm	128 mm x 128 mm	152 mm x 152 mm	162 mm x 162 mm
A/D transformer	16 bit			

Please note that not all components and features described in this brochure belong to the standard configurations but are part of an optional selection.

General Product Features

~ 3,000 x ~ 384,000 x 0.6 µm

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